

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5778689

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	SECURITY INTEREST
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MEDI-SOLVE COATINGS, LLC	10/03/2019
SANFORD PROCESS CORPORATION	10/03/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	M&T BANK
<b>Street Address:</b>	107 AUBURN ROAD, SUITE 2-102
<b>City:</b>	WAKEFIELD
<b>State/Country:</b>	MASSACHUSETTS
<b>Postal Code:</b>	01880
<b>PROPERTY NUMBERS Total: 5</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	11777234
Application Number:	12783130
Application Number:	12947197
Application Number:	14105049
Application Number:	15041725
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	202.370.4750
<b>Email:</b>	ipteam@coagencyglobal.com
<b>Correspondent Name:</b>	JENNIFER TINDIE
<b>Address Line 1:</b>	1025 VERMONT AVE NW, SUITE 1130
<b>Address Line 2:</b>	COGENCY GLOBAL INC.
<b>Address Line 4:</b>	WASHINGTON, D.C. 20005
<b>ATTORNEY DOCKET NUMBER:</b>	1143158
<b>NAME OF SUBMITTER:</b>	JANET S. WAMSLEY
<b>SIGNATURE:</b>	/Janet S. Wamsley/
<b>DATE SIGNED:</b>	10/21/2019
This document serves as an Oath/Declaration (37 CFR 1.63).	

PATENT

**Total Attachments: 5**

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GRANT OF SECURITY INTEREST  
IN UNITED STATES PATENTS

October 3, 2019

FOR GOOD AND VALUABLE CONSIDERATION, receipt and sufficiency of which are hereby acknowledged, each of the undersigned (each, individually, a "Grantor", and collectively, the "Grantors"), hereby grants to **M&T BANK**, a national banking association (in such capacity, the "Grantee"), a continuing security interest in (i) all of such Grantor's right, title and interest in, to and under the United States patents and patent applications (the "Patents") set forth on Schedule A attached hereto, (ii) all Proceeds (as such term is defined in that certain Loan Agreement by, among others, such Grantor and the Grantee, dated as of the date hereof) and products of the Patents, (iii) the goodwill of the businesses with which the Patents are associated, and (iv) all causes of action arising prior to or after the date hereof for infringement of any of the Patents.

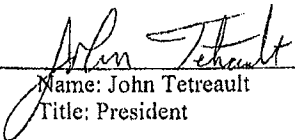
THIS GRANT OF SECURITY INTEREST IN UNITED STATES PATENTS (this "Grant") is made to secure the satisfactory performance and payment of all the Obligations of each Grantor, as such term is defined in the Loan and Security Agreement among, among others, the Grantors and the Grantee, dated as of the date hereof (as amended, modified, supplemented or restated hereafter, the "Loan Agreement").

This Grant has been granted in conjunction with the security interest granted to the Grantee under the Loan Agreement. The rights and remedies of the Grantee with respect to the security interest granted herein are as set forth in the Loan Agreement, all terms and provisions of which are incorporated herein by reference. In the event that any provisions of this Grant are deemed to conflict with the Loan Agreement, the provisions of the Loan Agreement shall govern.

[Remainder of Page Intentionally Blank]

IN WITNESS WHEREOF, the undersigned have executed this Grant as of the date above first written.

**SANFORD PROCESS CORPORATION,**  
as a Grantor

By:   
Name: John Tetreault  
Title: President

**MEDI-SOLVE COATINGS, LLC, as a**  
Grantor

By: \_\_\_\_\_  
Name: William G. Ellerkamp  
Title: Manager

Signature Page to Grant of Security Interest in United States Patents

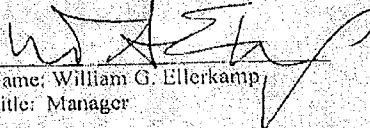


IN WITNESS WHEREOF, the undersigned have executed this Grant as of the date above first written.

SANFORD PROCESS CORPORATION,  
as a Grantor

By: \_\_\_\_\_  
Name: John Tetreault  
Title: President

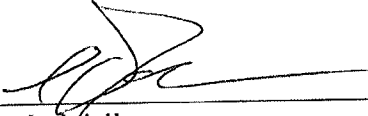
MEDI-SOLVE COATINGS, LLC, as a  
Grantor

By:   
Name: William G. Ellerkamp  
Title: Manager

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ACKNOWLEDGED AND ACCEPTED:

**M&T BANK,**  
as Grantee

By:   
Name: Dan Lobdell  
Title: Vice President

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**PATENT**  
**REEL: 050774 FRAME: 0484**

SCHEDULE A

List of Patents and Patent Licenses

<u>Patent Owner</u>	<u>Patent Name</u>	<u>Status</u>	<u>App. No.</u>	<u>Country/State of Formation</u>	<u>App. Filing Date</u>
Medi-Solve Coatings, LLC	MEDICAL DEVICES COMPRISING NON CROSS-LINKED, THIN AND FLEXIBLE AQUEOUS COATINGS, AND METHODS RELATED THERETO	Active	11/777,234	USA/Massachusetts	7/12/07
Sanford Process Corporation	MICROCRYSTALLINE ANODIC COATINGS AND RELATED METHODS THEREFOR	Active	12/783,130	USA/Delaware	5/19/10
Sanford Process Corporation	SEALED ANODIC COATINGS	Active	12/947,197	USA/Delaware	11/16/10
Sanford Process Corporation	MICROCRYSTALLINE ANODIC COATINGS AND RELATED METHODS THEREFOR	Active	14/105,049	USA/Delaware	12/12/13
Sanford Process Corporation	MICROCRYSTALLINE ANODIC COATINGS AND RELATED METHODS THEREFOR	Active	15/041,725	USA/Delaware	2/11/16